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Kulstad, K.; Svalgaard, Mikael

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THERMAL STABILITY OF DIRECTLY UV-WRITTEN WAVEGUIDES AND DEVICES

Kaj Kulstad and Mikael Svalgaard

Microelectronics Center, Bldg. 345 east, Technical University of Denmark
kaj@mic.dtu.dk
svl@mic.dtu.dk

Abstract: Accelerated aging experiments of directly UV-written straight waveguides, s-bends and directional couplers have been made. The results show that these structures are nearly unaffected by thousands of thermal cycles between +22 °C and +80 °C.

Introduction

A number of processes have been explored for fabrication of silica-on-silicon based planar waveguide devices, most of them involving a fairly large number of process steps consisting of glass film deposition, photolithography and etching procedures [1]. We have recently shown that waveguides and devices may alternatively be directly written into a photosensitive glass sample that is scanned under a focussed ultraviolet (UV) laser beam [2,3]. This method yields high quality devices, has the advantage of involving very few process steps and has sufficient capacity for mass production [4]. It is well known from work involving fiber Bragg gratings that UV induced index changes generally are unstable over extended periods of time due to thermal bleaching of optically induced defect centers [5]. Since directly written planar waveguide devices consist entirely of such defects the index-change stability requirements may be much more stringent than what is currently accepted for devices based on fiber Bragg gratings where the UV exposed region only constitutes a small fraction of the total device layout. It is therefore of great importance to investigate the long-term stability of directly UV written devices.

In this paper we present results from accelerated aging experiments of directly written straight waveguides, s-bends and directional couplers.

Experimental (UV writing)

Planar waveguides have been written into a photosensitive glass film using a focussed 244 nm continuous wave UV laser and high precision, three dimensional translation stages [2]. The sample used here is fabricated by plasma enhanced chemical vapour deposition and consists of a three layer silica film waveguide on a silicon wafer. The film waveguide core layer is ~2.5 μm thick and contains about 13 mole % GeO₂ [6]. The UV spot diameter on the sample was 5 μm and the incident power was 17 mW. The sample was prior to the UV exposure loaded with ~2 mole % D₂ to increase the photosensitivity. After UV processing the sample is annealed at 80 °C for several days to permit outdiffusion of residual D₂.

Experimental (accelerated aging)

Insertion loss measurements were performed at room temperature by launching light from a 1.54 μm diode laser through the waveguides using butt coupled standard telecom fibers. Prior to the accelerated aging experiments the sample was subjected to a four hour pre-annealing at 150 °C, thereby removing the most unstable defect centers and increasing the stability of the remaining structure. The accelerated aging experiments were carried out by placing the sample on a vacuum chuck, where the temperature could be varied from a room temperature of 22 °C and up to 80 °C. This temperature range was chosen to resemble that used for the testing described in the Bellcore specifications [6]. The sample was loaded with 10 cycles (2800+ cycles).

Results (linear and curved waveguides)

The linear waveguides each contain a Bragg grating that was photoinduced with an excimer laser and a phasemask. The Bragg wavelength is ~1.56 μm and could be determined to an accuracy of ±0.05 nm using a broad band light source and an optical spectrum analyser. The effective index of the guided mode can be determined from nₑff = λbragg /2λ₀, where nₑff is the effective refractive index of the guided mode and λ₀ is the period of the phase mask. Hence, these gratings serve as an accurate indicator of the effective index of the host waveguide. Part of the sample contains linear (reference) waveguides without Bragg grating and waveguides made up from multiple s-bends [3]. The s-bends consist of circular arcs with a radius of curvature of 10, 13.5, 20 and 30 mm and a transverse displacement of 100 μm. Each waveguide contains four s-bends in series to increase the measurement sensitivity towards changes in the s-band properties.

Bragg wavelength and insertion loss measurements were carried out at 0, 300, 800, 1600 and 2800 cycles. No change in the Bragg wavelength could be discerned throughout the cycling experiment; i.e. any changes in the effective index must be smaller than ± 5×10⁻³. In addition, no change in the excess loss of the different s-bends could be observed within the measurement accuracy of ±0.15 dB.

Results (Directional couplers)

The sample also contains several four port directional couplers, which should be much more sensitive towards small changes of the UV induced index change than isolated waveguides. The couplers were written with a 9μm waveguide center-to-center spacing in the central coupling region and the length of this region, L, was varied from 500 μm to 2600 μm [4]. The coupler excess loss compared to a linear reference waveguide is typically a few tenths of a dB and the coupling ratio is symmetrical with respect to which input arm is excited. The normalised coupling ratio is defined by C = (P₁/P₁+P₂), where P₁ and P₂ is the power measured at output arm 1 and...
From coupled mode theory, it follows [1] that the normalised coupling ratio is given by:

\[ \alpha = 1 - F^2 \sin^2 \left( \frac{0.5\pi(L + \Delta L)}{L_c} \right) \]  

(1)

where \( F^2 \) is the maximum fraction of the total power that can be transferred from one waveguide to the other. \( L_c \) is the coupling length and \( \Delta L \) is a change in the effective length of the linear coupling region due to coupling occurring in the bends. This form of the coupling ratio has been fitted to the measured values as a function of the coupling length, thereby yielding values for \( F^2 \), \( L_c \), and \( \Delta L \). In figure 1 \( \Delta L \) and \( L_c \) are plotted versus the number of cycles, while \( F^2 \) is plotted in figure 2. Both \( \Delta L \) and \( L_c \) change only very slightly throughout the experiment; after 2800 cycles \( \Delta L \) appears to have decreased by \(-2\%\) while \( L_c \) has decreased by \(-4\%\). Decreasing coupling lengths are consistent with a slightly decreasing index change leading to slightly less confined mode profiles and thus also a greater mode overlap integral and hence a more rapid power transfer. The measured values for \( F^2 \) shows a gradual decrease from about 0.984 to 0.968. The measured excess loss of the couplers remained unaffected by the cycling. It should be possible to reduce the observed changes in the coupling parameters even further by increasing the pre-annealing temperature, as suggested in reference 5.

**Fig. 1: The coupler parameters \( \Delta L \) and \( L_c \) versus the number of thermal cycles**

**Fig. 2: The maximum fraction of power transferred between the waveguides versus the number of thermal cycles.**

**Conclusion**

The performance of directly UV-written waveguides and devices is shown to be affected very little by thousands of thermal cycles between +22 °C and +80 °C. For linear waveguides and s-bends no effects could be seen. For directional couplers the coupling length varies by less than 2% while the excess loss remains unaffected.

**References**


